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Thyristor/Thyristor, 150 A (New INT-A-PAK Power Module)



New INT-A-PAK

PRODUCT SUMMARY						
I _{T(AV)}	150 A					
Туре	Modules - Thyristor, Standard					
Package	INT-A-PAK					
Circuit	Two SCRs doubler circuit					

FEATURES

• Electrically isolated by DBC ceramic (Al₂O₃)



- 3500 V_{RMS} isolating voltage
- and Hill and Hill
- Industrial standard package
- High surge capability
- · Glass passivated chips
- Simple mounting
- UL approved file E78996
- Designed and qualified for multiple level
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Battery charges
- Welders
- Power converters

MAJOR RATINGS AND CHARACTERISTICS								
SYMBOL	CHARACTERISTICS	VALUES	UNITS					
I _{T(AV)}	85 °C	150	Α					
I _{T(RMS)}		330						
1	50 Hz	4000	Α					
I _{TSM}	60 Hz	4200						
l ² t	50 Hz	80	kA ² s					
<u> </u> -ί	60 Hz	73	KA-5					
I ² √t		800	kA ² √s					
V_{RRM}		400	V					
T _{Stg}	Range	-40 to 150	°C					
T_J	Range	-40 to 125						

ELECTRICAL SPECIFICATIONS

VOLTAGE RATINGS								
TYPE NUMBER	V _{RRM} /V _{DRM} , MAXIMUM REPETITIVE PEAK REVERSE VOLTAGE V	V _{RSM} /V _{DSM} , MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE V	I _{RRM} /I _{DRM} AT 125 °C mA					
VS-VSKT152/04PbF	400	500	50					



ON-STATE CONDUCTION						
PARAMETER	SYMBOL	TEST CONDITIONS			VALUES	UNITS
Maximum average on-state current	I _{T(AV)}	180° conductio	on half sine wave		150	А
at case temperature	.(,				85	°C
Maximum RMS on-state current	I _{T(RMS)}	As AC switch			330	
		t = 10 ms	No voltage		4000	
Maximum peak, one-cycle on-state, non-repetitive	l	t = 8.3 ms	reapplied		4200	Α
surge current	ge current t = 10 ms 100 %	t = 10 ms	100 % V _{RRM}		3350	
		reapplied	reapplied Sine half wave,	3500	<u> </u>	
	l ² t	t = 10 ms	No voltage reapplied	initial $T_J = T_J$ maximum	80	kA ² s
Maximum I ² t for fusing		t = 8.3 ms			73	
waxiiiluiii i-t ioi lusiiig		t = 10 ms			56	
		t = 8.3 ms	reapplied		51	
Maximum I ² √t for fusing	I²√t	t = 0.1 ms to 10	0 ms, no voltage r	reapplied	800	kA ^{2√} s
Value of threshold voltage	V _{T(TO)}	T. _I maximum			0.82	V
On-state slope resistance	r _t	ı j maximum		1.44	mΩ	
Maximum on-state voltage drop	V _{TM}	$I_{pk} = \pi \times I_{T(AV)}, T_J = 25 ^{\circ}C$			1.48	V
Maximum holding current	I _H	T _J = 25 °C, anode supply = 6 V, resistive load, gate open circuit			200	mA
Maximum latching current	IL	$T_J = 25$ °C, and	ode supply = 6 V,	resistive load	400	

SWITCHING					
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS
Typical delay time	t _{gd}	T _{.1} = 25 °C	Gate current = 1 A, dl _a /dt = 1 A/µs	1	
Typical rise time	t _{gr}	1j = 25 C	$V_{d} = 0.67 \% V_{DRM}$	2	μs
Typical turn-off time	t _q	I_{TM} = 300 A, - dl/dt = 15 A/ μ s; T $_J$ = T $_J$ maximum V_R = 50 V; dV/dt = 20 V/ μ s; gate 0 V, 100 Ω		50 to 200	

BLOCKING							
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS			
Maximum peak reverse and off-state leakage current	I _{RRM,} I _{DRM}	T _J = 125 °C	50	mA			
RMS insulation voltage	V _{INS}	50 Hz, circuit to base, all terminals shorted, t = 1 s	3500	V			
Critical rate of rise of off-state voltage	dV/dt	T _J = T _J maximum, exponential to 67 % rated V _{DRM} 1000					



TRIGGERING						
PARAMETER	SYMBOL	TEST COM	VALUES	UNITS		
Maximum peak gate power	P _{GM}	$t_p \le 5 \text{ ms}, T_J = T_J \text{ maxim}$	num	12	W	
Maximum average gate power	P _{G(AV)}	$f = 50 \text{ Hz}, T_J = T_J \text{ maxim}$	num	3] vv	
Maximum peak gate current	I _{GM}			3	А	
Maximum peak negative gate voltage	- V _{GT}	$t_p \le 5 \text{ ms}, T_J = T_J \text{ maxim}$	num	10		
		T _J = - 40 °C		4	V	
Maximum required DC gate voltage to trigger	V_{GT}	T _J = 25 °C		2.5		
voltago to triggor		$T_J = T_J$ maximum Anode supply = 6 V,		1.7		
		T _J = - 40 °C	resistive load; $R_a = 1 \Omega$	270		
Maximum required DC gate current to trigger	I _{GT}	T _J = 25 °C	T _J = 25 °C		mA	
our one to triggor		T _J = T _J maximum		80	l	
Maximum gate voltage that will not trigger	V _{GD}	T T	V soulised	0.3	V	
Maximum gate current that will not trigger	I _{GD}	$T_J = T_J$ maximum, rated	v _{DRM} applied	10	mA	
Maximum rate of rise of turned-on current	dl/dt	$T_J = T_J$ maximum, $I_{TM} = 4$	400 A rated V _{DRM} applied	300	A/µs	

THERMAL AND MECHANICAL SPECIFICATIONS							
PARAMETER		SYMBOL	SYMBOL TEST CONDITIONS		UNITS		
Maximum junction temperature range		TJ		- 40 to 125	°C		
Maximum storage temperature range		T _{Stg}		- 40 to 150	C		
Maximum thermal resistance, junction to case per junction R _{thJC}		R _{thJC}	DC operation	0.18	K/W		
Maximum thermal resistance, case to heatsink per module		R _{thCS}	Mounting surface smooth, flat and greased	0.05	r./ vv		
Mounting	IAP to heatsink		A	4 to 6	Nm		
torque ± 10 %	busbar to IAP		A mounting compound is recommended and the torque should be rechecked after a period of	4 10 6	INIII		
Approximate weig	.ht		3 hours to allow for the spread of the compound. Lubricated threads.	200	g		
Approximate weig	Approximate weight		Lubilicated till cads.	7.1	oz.		
Case style				INT-A-	PAK		

△R CONDUCTION PER JUNCTION											
SINUSOIDAL CONDUCTION RECTANGULAR CONDUCTION AT T _J MAXIMUM AT T _J MAXIMUM								UNITS			
	180°	120°	90°	60°	30°	180°	120°	90°	60°	30°	
VSKT152/04PbF	0.007	0.010	0.013	0.016	0.017	0.009	0.012	0.014	0.016	0.017	K/W

Note

• Table shows the increment of thermal resistance R_{thJC} when devices operate at different conduction angles than DC

www.vishay.com

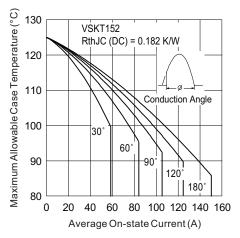


Fig. 1 - Current Ratings Characteristics

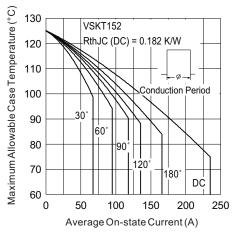


Fig. 2 - Current Ratings Characteristics

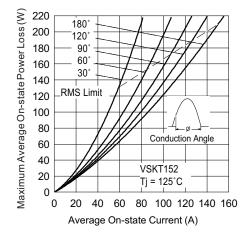


Fig. 3 - Forward Power Loss Characteristics

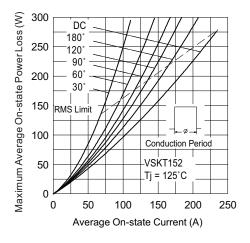


Fig. 4 - Forward Power Loss Characteristics

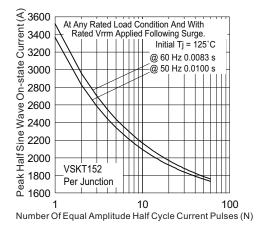


Fig. 5 - Maximum Non-Repetitive Surge Current

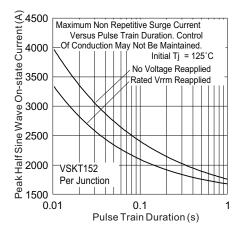


Fig. 6 - Maximum Non-Repetitive Surge Current

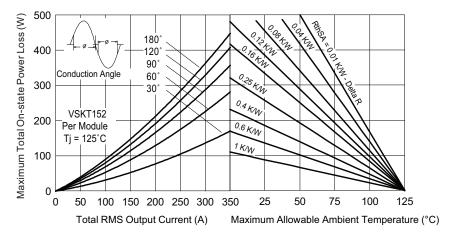


Fig. 7 - On-State Power Loss Characteristics

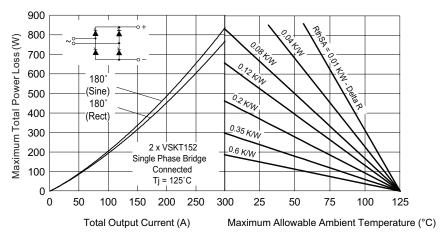


Fig. 8 - On-State Power Loss Characteristics

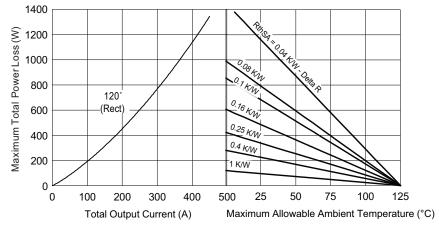


Fig. 9 - On-State Power Loss Characteristics



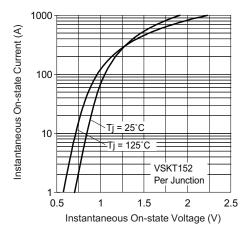


Fig. 10 - On-State Voltage Drop Characteristics

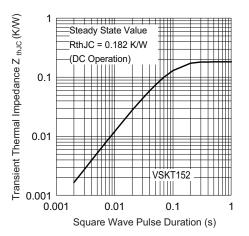


Fig. 11 - Thermal Impedance Z_{thJC} Characteristics

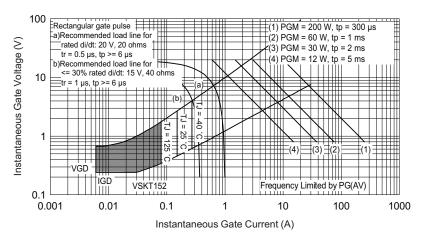
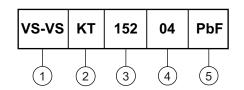


Fig. 12 - Gate Characteristics

ORDERING INFORMATION TABLE

Device code



1 - Vishay Semiconductors product

2 - Circuit configuration

3 - Current rating

Voltage rating (04 = 400 V)

5 - PbF = Lead (Pb)-free

Note

• To order the optional hardware go to www.vishay.com/doc?95172

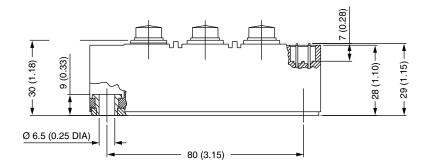
CIRCUIT CONFIGURATION	CIRCUIT CONFIGURATION							
CIRCUIT DESCRIPTION	CIRCUIT CONFIGURATION CODE	CIRCUIT DRAWING						
Two SCRs doubler circuit	Т	10~ 20+ NO 05 70 04 60						

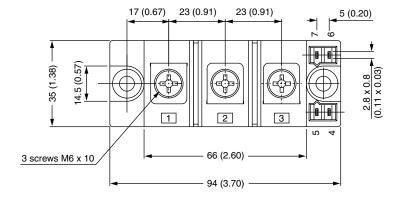
LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?95067			

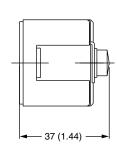


INT-A-PAK IGBT/Thyristor

DIMENSIONS in millimeters (inches)









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